AMINED BY:		FILE NO . CAS-0006273
Yung Chang Hu	EMERGING DISPLAY	ISSUE : SEP.12, 2007
PROVED BY:	TECHNOLOGIES CORPORATION	TOTAL PAGE: 30
David Chang		VERSION: 1
CUSTOMER	ACCEPTANCE SPEC	CIFICATIONS
	DEL NO.:  ET035009DH6 (RoHS)  MESSRS:	
DATE :		
	<del></del>	
BY:		
	<del></del>	

# MODEL NO. VERSION PAGE EMERGING DISPLAY TECHNOLOGIES CORPORATION ET035009DH6(RoHS) 1 0 - 1DOC . FIRST ISSUE SEP.12, 2007 RECORDS OF REVISION REVISED DATE PAGE SUMMARY NO.

E T 0 3 5 0 0 9 D H 6 (RoHS)

version 1 PAGE 0-2

TABLE OF CONTENTS

NO.	TTEM	PAGE 
1.	GENERAL SPECIFICATIONS	1
2.	MECHANICAL SPECIFICATIONS	1
3.	ABSOLUTE MAXIMUM RATINGS	2
4.	ELECTRICAL CHARACTERISTICS	3
5.	TIMING CHART	4 ~ 6
6.	OPTICAL CHARACTERISTICS	7,8
7.	OUTLINE DIMENSIONS	9
8.	BLOCK DIMENSIONS	10
9.	DETAIL DRAWING OF DOT MATRIX	11
10.	INTERFACE SIGNAL	12, 13
11.	POWER SUPPLY	14
12.	TOUCH PANEL SPECIFICATION	15 ~ 20
12.	SPECIFICATION OF AUDACITY ASSURANCE	21 ~ 30

EMERGING DISPLAY	MODEL NO.	VERSION	_
TECHNOLOGIES CORPORATION	ET035009DH6(RoHS)	1	

#### 1. GENERAL SPECIFICATIONS

1.1 APPLICATION NOTES FOR CONTROLLER/DRIVER PLEASE REFER TO :

#### HX8238-A

1 . 2 MATERIAL SAFETY DESCRIPTION
ASSEMBLIES SHALL COMPLY WITH EUROPEAN ROHS REQUIREMENTS,
INCLUDING PROHIBITED MATERIALS/COMPONENTS CONTAINING LEAD,
MERCURY, CADMIUM, HEXAVALENT CHROMIUM, POLYBROMINATED
BIPHENYLS (PBB) AND POLYBROMINATED

DIPHENYL ETHERS (PBDE)

#### 2. MECHANICAL SPECIFICATIONS

	(1) DISPLAY SIZE	(inch)	3.5"
	(2) NUMBER OF	DOTS	320W * (RGB) * 240H DOTS
	(3) MODULE SIZE	E	76.8W * 63.8H * 4.4(D) mm
			(WITHOUT FPC)
	(4) EFFECTIVE AR	REA	72.2W*54.76H mm (T/P)
	(5) ACTIVE AREA		70.08W * 52.56H mm (LCD)
			70.8W * 53.26H mm (T/P)
	(6) DOT SIZE		0.073W * 0.219H mm
	(7) PIXEL SIZE		0.219W * 0.219H mm
	(8) LCD TYPE		TFT , TRANSMISSIVE
	(9) COLOR		262K (24BIT)
(	10) VIEWING DIR	RECTION	6 O'CLOCK
(	11) BACK LIGHT		LED . COLOR : WHITE

PAGE

### E M E R G I N G D I S P L A Y TECHNOLOGIES CORPORATION

MODEL NO.	VERSION	PAGE
E T 0 3 5 0 0 9 D H 6 (RoHS)	1	2

#### 3. ABSOLUTE MAXIMUM RATINGS

#### 3.1 ELECTRICAL ABSOLUTE MAXIMUM RATINGS.

PARAMETER	SYMBOL	MIN.	MAX.	UNIT	REMARK
POWER VOLTAGE	VDD	VSS-0.3	5.0	V	
FOWER VOLTAGE	VCC	-0.3	4.0	V	_
POWER DISSIPATION	PD		540	mW	
FORWARD CURRENT	IF	_	25	mA	_
REVERSE VOLTAGE	VR	_	30	V	_

#### 3.2 ENVIRONMENTAL ABSOLUTE MAXIMUM RATINGS.

ITEM	OPER.	ATING	STOF	RAGE	REMARK
I I E IVI	MIN.	MAX.	MIN.	MAX.	KEMAKK
AMBIENT TEMPERATURE	-10°C	60°C	-20°C	70°C	NOTE (1), (2)
HUMIDITY	NOT	E(3)	NOT	E(2)	WITHOUT
HOMIDIT I	NOT	E(3)	NOT	E(3)	CONDENSATION
VIBRATION	_	2.45m/s <sup>2</sup> ( 0.25G)	_	11.76m/s <sup>2</sup> (1.2G)	5~20Hz , 1HR 20~500Hz(20Hz) , 1HR 20~500Hz(500Hz) , 1HR X,Y,Z,TOTAL 3HR
SHOCK		29.4m/s <sup>2</sup> (3G)	_	490m/s <sup>2</sup> ( 50G )	10 m SECONDS XYZ DIRECTIONS 1 TIME EACH
CORROSIVE GAS	NOT ACC	EPTABLE	NOT ACC	EPTABLE	

NOTE (1): Ta AT -20°C: 48HR MAX.

70°C:168HR MAX.

NOTE (2): BACKGROUND COLOR CHANGES SLIGHTLY DEPENDING ON AMBIENT

TEMPERATURE THIS PHENOMENON IS REVERSIBLE.

NOTE (3) :  $Ta \le 60$ °C : 90%RH MAX (96HRS MAX).

 $\mbox{Ta} > 60\mbox{°C}: \mbox{Absolute humidity must be lower than the humidity}$ 

OF 90%RH AT 60°C(96HRS MAX).

MODEL NO.	VERSION	PAGE
ET035009DH6(RoHS)	1	3

#### 4. ELECTRICAL CHARACTERISTICS

 $Ta = 25 \, ^{\circ}C$ 

	1	ı					
PARAMETER	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT	REMARK
DIGITAL POWER SUPPLY	VCC	_	2.5	3.3	3.6	V	
ANALOG POWER SUPPLY	VDD	_	2.5	3.3	3.6	V	
DIGITAL OPERATING CURRENT	ICC	_	_	(1)	(2)	mA	
ANALOG OPERATING CURRENT	IDD	_	_	(10)	(15)	mA	
LOGIC HIGH OUTPUT VOLTAGE	VOH	IOUT=-100μA	0.9*VCC	_	VCC	V	
LOGIC LOW OUTPUT VOLTAGE	VOL	IOUT=100μA	0		0.1*VCC	V	
LOGIC HIGH INPUT VOLTAGE	VIH	H LEVEL	0.8*VCC		VCC	V	
LOGIC LOW INPUT VOLTAGE	VIL	L LEVEL	0		0.2*VCC	V	
FORWARD VOLTAGE	$V_{\rm F}$	IF=20mA	19.2	20.4	21.6	V	NOET(1)
LED LIFE TIME		_	30k	40k		hr	

#### NOET(1): INTERNAL CIRCUIT DIAGRAM OF BACKLIGHT

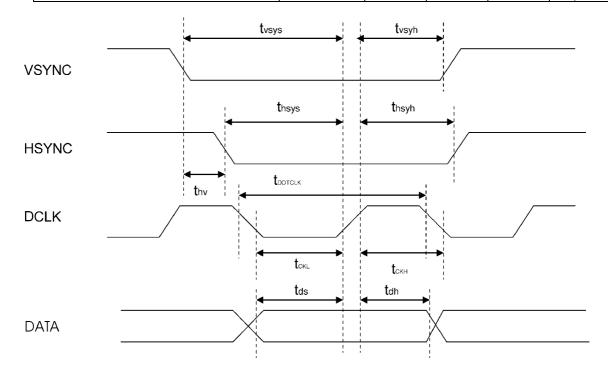


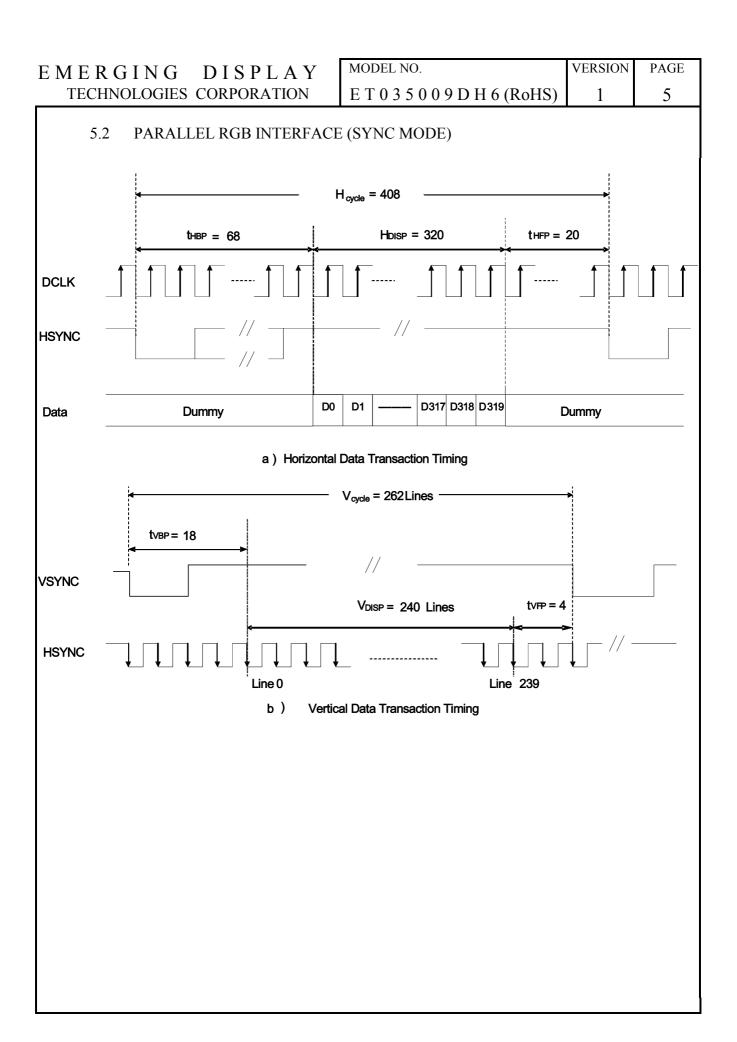
MODEL NO.	VERSION	PAGE
ET035009DH6(RoHS)	1	4

#### 5. TIMING CHART

#### 5.1 DIGITAL PARALLEL RBG INTERFACE

CHARACTERISTICS	SYMBOL	MIN.	TYP.	MAX.	UNIT
DCLK FREQUENCY	fDCLK		6.5	10	MHz
DCLK PERIOD	tDCLK	100	154		ns
VERTICAL SYNC SETUP TIME	tvsys	20			ns
VERTICAL SYNC HOLD TIME	tvsyh	20	_		ns
HORIZONTAL SYNC SETUP TIME	thsys	20			ns
HORIZONTAL SYNC HOLD TIME	tvsyh	20			ns
PHASE DIFFERENCE OF SYNC SIGNAL FALLING EDGE	thv	1		240	tDCLK
DCLK LOW PERIOD	tCKL	50			ns
DCLK HIGH PERIOD	tCKH	50			ns
DATA SETUP TIME	tds	12			ns
DATA HOLD TIME	tdh	12	_		ns
RESET PULSE WIDTH	tRES	10			μs





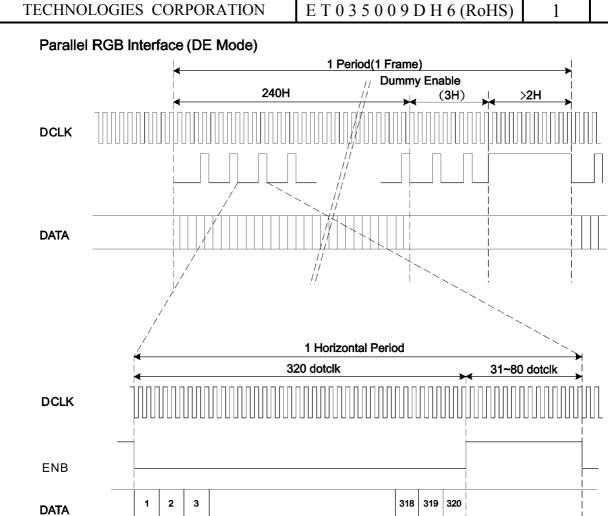
### EMERGING DISPLAY

ET035009DH6(RoHS)

MODEL NO.

VERSION PAGE

6



CHARACTERISTICS		SYMBOL	MIN.	TYP.	MAX.	
DCLK FREQUENCY		fDCLK		6.5	10	MHz
DCLK PERIOD		tDCLK	100	154		ns
HORIZONTAL FREQUENCY (L	INE)	fH	_	14.9	22.35	KHz
VERTICAL FREQUENCY (REFI	RESH)	fV		60	90	Hz
HORIZONTAL BACK PORCH		tHBP		68	_	tDCLK
HORIZONTAL FRONT PORCH		tHFP		20	_	tDCLK
HORIZONTAL DATA START P	OINT	tHBP	_	68	_	tDCLK
HORIZONTAL BLANKING PERIOD		tHBP + tHFP		88	_	tDCLK
HORIZONTAL DISPLAY AREA		HDISP		320	_	tDCLK
HORIZONTAL CYCLE		Hcycle		408	450	tDCLK
VERTICAL BACK PORCH		tVBP		18	_	Lines
VERTICAL FRONT PORCH		tVFP	_	4	_	Lines
VERTICAL DATA START POIN	T	tVBP	_	18	_	Lines
VERTICAL BLANKING PERIOR	)	tVBP + tVFP		22	_	Lines
	NTSC		_	240	_	
VERTICAL DISPLAY AREA	PAL	VDISP		280(PALM=0)		Lines
	PAL			280(PALM=1)		
VERTICAL CYCLE	NTSC	Vcycle		262	350	Lines
VERTICAL CICLE	PAL	v cycle		313	330	Lilles

Valid Data transfer area

MODEL NO.	VERSION	PAGE
ET035009DH6(RoHS)	1	7

#### 6. OPTICAL CHARACTERISTICS (NOTE1)

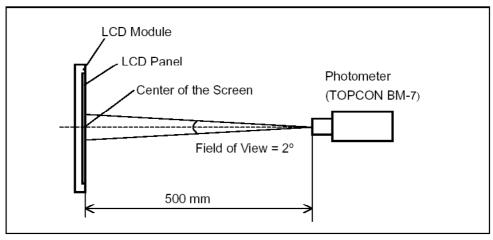
#### 6.1 OPTICAL CHARACTERISTICS

 $Ta = 2.5 \pm 2$ °C

ITE	M	SYMBOL	COND	ITION	MIN.	TYP.	MAX.	UNIT	REMARK
		$\theta_{y^+}$	0	0 -00	(50)	(55)			
VIEWING ANGL	E	$\theta_{ ext{y-}}$	CD > 10	$\theta_{x}=0$ °	(70)	(75)		deg.	(2),(3)
VIEWING ANGL	E	$\theta_{x^+}$	CK ≥ 10	CR ≥ 10	(70)	(75)			
		$\theta_{x}$		$\theta_y=0^{\circ}$	(70)	(75)			
CONTRAST RAT	IO	CR	θx=0°,	θy=0°	(300)	(400)			(3)
RESPONSE TIMI	3	tr(rise)	0v-0°	000		15	20	msac	(4)
RESPONSE TIME	ت	tf(fall)	$\theta x=0^{\circ}, \ \theta y=0^{\circ}$			35	50	msec	(4)
THE BRIGHTNESS OF MODULE B		В	θx=0°, IF=2		(300)	(400)		cd/m <sup>2</sup>	(5)
	WHITE	X				(0.286)	(0.336)		
	WHILE	Y			(0.261)	(0.311)	(0.361)		
	RED	X			(0.562)	(0.612)	(0.662)		
COLOR OF CIE	KED	Y	θx=0°,	θy=0° 0mA	(0.305)	(0.355)	(0.405)		(6)
COORDINATE	GREEN	X	NTSC :		(0.262)	(0.312)	(0.362)		
BLUE	OKEEN	Y		,	(0.533)	(0.583)	(0.633)		
	DITTE	X			(0.090)	(0.140)	(0.190)		
	DLUE	Y			(0.020)	(0.070)	(0.120)		
THE UNIFORMITY OF BRIGHTNESS		_	_	_	(70)			%	_

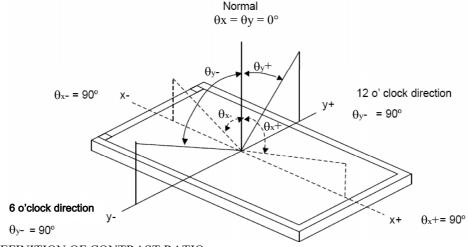
#### NOTE (1): TEST EQUIPMENT SETUP:

AFTER STABILIZING AND LEAVING THE PANEL ALONE AT A GIVEN TEMPERATURE FOR 30 MINUTES , THE MEASUREMENT SHOULD BE EXECUTED. MEASUREMENT SHOULD BE EXECUTED IN A STABLE , WINDLESS , AND DARK ROOM. OPTICAL SPECIFICATIONS ARE MEASURED BY TOPCON BM-7 (FAST) WITH A VIEWING ANGLE OF  $2^\circ$  AT A DISTANCE OF 50cm AND NORMAL DIRECTION.



MODEL NO.	VERSION	PAGE
ET035009DH6(RoHS)	1	8

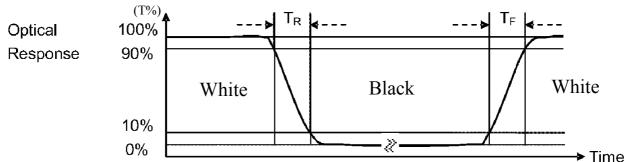
NOTE (2): DEFINITION OF VIEWING ANGLE:



NOTE (3): DEFINITION OF CONTRAST RATIO:

 $\label{eq:contrastratio} \text{CONTRASTRATIO}(\text{CR}) = \frac{\text{BRIGHTNESS MEASURED WHEN LCD IS AT "WHITE STATE"}}{\text{BRIGHTNESS MEASURED WHEN LCD IS AT "BLACK STATE"}}$ 

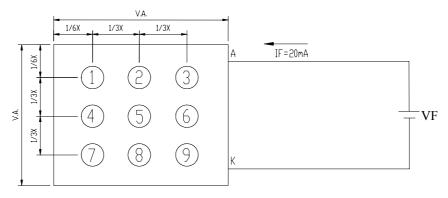
NOTE (4): DEFINITION OF RESPONSE TIME: TR AND TF
THE FIGURE BVELOW IS THE OUTPUT SIGNAL OF THE PHOTO DETECTOR.



NOTE (5): BRIGHTNESS MEASURED WHEN LCD IS AT "WHITE STATE"

NOTE (6): THE 100% TRANSMISSION IS DEFINED AS THE TRANSMISSION OF LCD PANEL WHEN ALL THE INPUT TERMINALS OF MODULE ARE ELECTRICALLY OPENED.

#### 6.2 THE TEST METHOD OF BRIGHTNESS AND UNIFORMITY

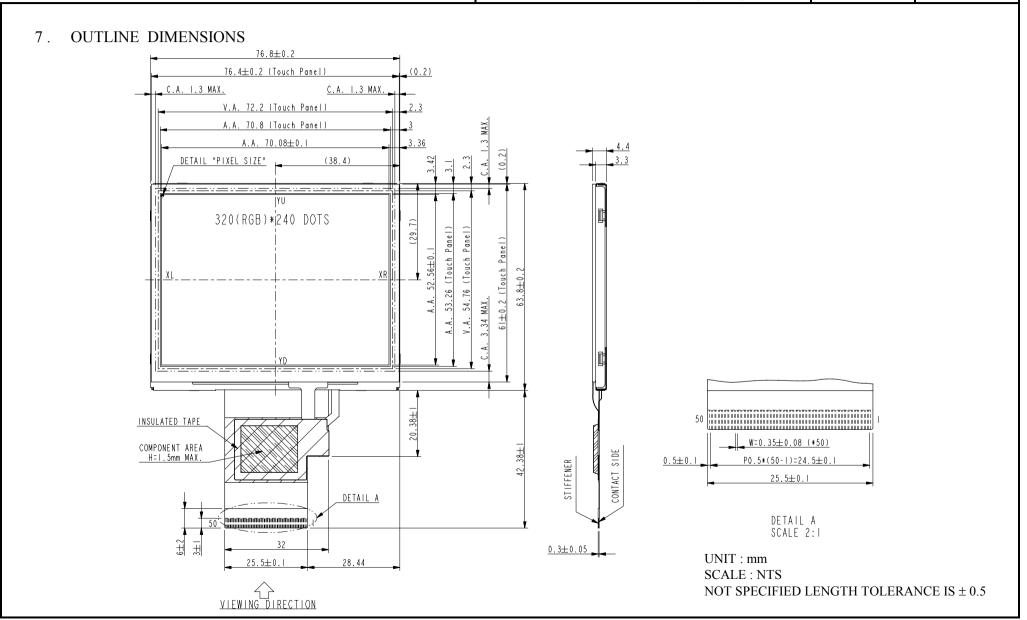


UNIT: mm

#### 6.3 THE CALCULATING METHOD OF UNIFORMITY

### E M E R G I N G D I S P L A Y TECHNOLOGIES CORPORATION

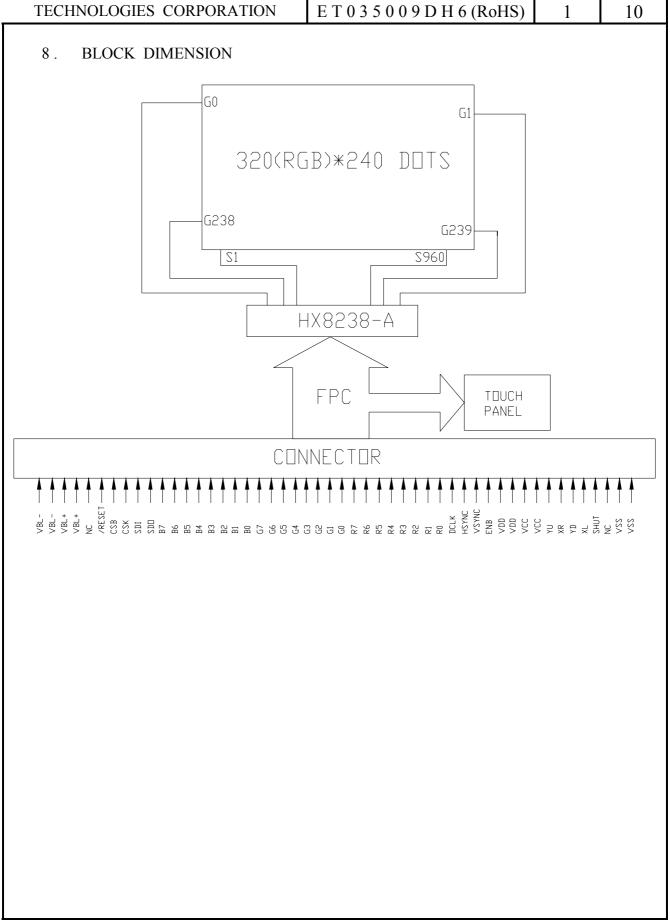
MODEL NO.	VERSION	PAGE
E T 0 3 5 0 0 9 D H 6 (RoHS)	1	9



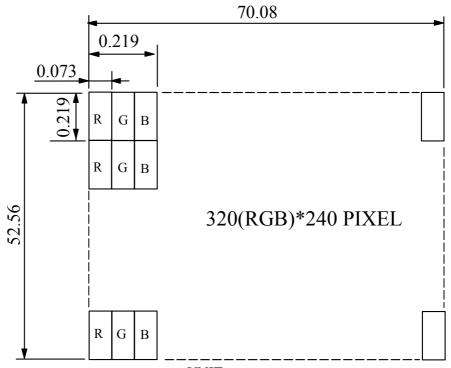
### EMERGING DISPLAY

 MODEL NO.
 VERSION
 PAGE

 E T 0 3 5 0 0 9 D H 6 (RoHS)
 1
 10



#### 9. DETAIL DRAWING OF DOT MATRIX



UNIT : mm SCALE : NTS

NOT SPECIFIED TOLERANCE IS  $\pm$  0.1 DOTS MATRIX TOLERANCE IS  $\pm$  0.01

 MODEL NO.
 VERSION
 PAGE

 E T 0 3 5 0 0 9 D H 6 (RoHS)
 1
 12

#### 10. INTERFACE SIGNALS

PIN NO	SYMBOL	I/O	FUNCTION	
1	VBL-	P	BACKLIGHT LED GROUND (K)	
2	VBL-	P	BACKLIGHT LED GROUND (K)	
3	VBL+	P	BACKLIGHT LED POWER (A)	
4	VBL+	P	BACKLIGHT LED POWER (A)	
5	NC		NOT USE	
6	/RESET	I	HARDWARE RESET	
7	CSB	I	SPI INTERFACE CHIP SELECT BAR	
8	SCK	I	SPI INTERFACE DATA CLOCK	
9	SDI	I	SPI INTERFACE DATA (INPUT)	
10	SDO	О	SPI INTERFACE DATA(OUTPUT)	
11	В7	I	BLUE DATA BIT 7	
12	В6	I	BLUE DATA BIT 6	
13	B5	I	BLUE DATA BIT 5	
14	B4	I	BLUE DATA BIT 4	
15	В3	I	BLUE DATA BIT 3	
16	B2	I	BLUE DATA BIT 2	
17	B1	I	BLUE DATA BIT 1	
18	В0	I	BLUE DATA BIT 0	
19	G7	I	GREEN DATA BIT 7	
20	G6	I	GREEN DATA BIT 6	
21	G5	I	GREEN DATA BIT 5	
22	G4	I	GREEN DATA BIT 4	
23	G3	I	GREEN DATA BIT 3	
24	G2	I	GREEN DATA BIT 2	
25	G1	I	GREEN DATA BIT 1	
26	G0	I	GREEN DATA BIT 0	
27	R7	I	RED DATA BIT 7	
28	R6	I	RED DATA BIT 6	
29	R5	I	RED DATA BIT 5	
30	R4	I	RED DATA BIT 4	
31	R3	I	RED DATA BIT 3	
32	R2	I	RED DATA BIT 2	
33	R1	I	RED DATA BIT 1	
34	R0	I	RED DATA BIT 0	

 MODEL NO.
 VERSION
 PAGE

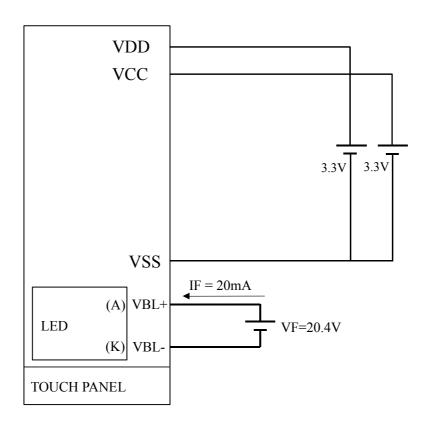
 E T 0 3 5 0 0 9 D H 6 (RoHS)
 1
 13

PIN NO	SYMBOL	I/O		FUNCTION		
35	DCLK	I	DOT DATA COLCK	DOT DATA COLCK		
36	HSYNC	I	HORIZONTAL SYNC INPU	UT		
37	VSYNC	I	VERTICAL SYNC INPUT			
38	ENB	I	DATA ENABLE INPUT			
39	VDD	P	ANALOG POWER			
40	VDD	P	ANALOG POWER			
41	VCC	P	DIGITAL POWER	DIGITAL POWER		
42	VCC	P	DIGITAL POWER			
43	YU	I	TOP PANEL			
44	XR	I	RIGHT PANEL	TOUCH PANEL INTERFACE		
45	YD	I	BOTTOM PANEL	SIGNALS		
46	XL	I	LEFT PANEL			
47	SHUT	I	DISPLAY SHUT DOWN PIN TO PUT THE DRIVER INTO SLEEP MODE. CONNECT TO VCC FOR SLEEP MODE. CONNECT TO VSS FOR NORMAL OPERATING MODE.			
48	NC		NOT USE			
49	VSS	P	GROUND			
50	VSS	P	GROUND			

MODEL NO. VERSION PAGE ET035009DH6(RoHS) 1 14

#### 11. POWER SUPPLY

#### 11.1 POWER SUPPLY FOR LCM



MODEL NO.	VERSION	PAGE
ET035009DH6(RoHS)	1	15

#### 12. TOUCH PANEL SPECIFICATION

#### 12.1 ELECTRICAL CHARACTERISTICS

 $Ta = 25^{\circ}C$ 

ITEM	CONDITION	SPEC.	UNIT
LINEARITY	_	1.5	%
TERMINAL RESISTANCE	X AXIS	200 ~ 900	0
TERMINAL RESISTANCE	Y AXIS	200 ~ 900	22
INSULATION RESISTANCE	DC25V	20	$M\Omega$

#### 12.2 ABSOLUTE MAXIMUM RATINGS:

ITEM	MIN.	TYP.	MAX.
OPERATING TEMPERATURE (Top)	-10°C		60°C
STORAGE TEMPERATURE (Tst)	-20°C	_	+70°C
INPUT VOLTAGE (V)	_	5	_

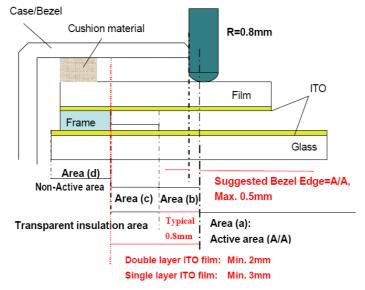
#### 12.3 PRECAUTIONS IN USE OF TOUCH PANEL

#### 12.3.1 PURPOSE :

IN ORDER TO PREVENT ACCIDENTAL USE AND PERFORMANCE DETERIORATION, PLEASE KEEP THE FOLLOWING PRECAUTIONS AND INHIBITED POINTS.

#### 12.3.2 ITEM AND ILLUSTRATION:

(1) STRUCTURE, AREA DEFINITION
THE STRUCTURE AND THE PERFORMANCE GUARANTEED AREA OF THIS
TOUCH PANEL ARE DEFINED BELOW:



THE ABOVE FIGURE IS OUR DESIGN RULE OF TOUCH PANEL. IF IT CANNOT MEET YOUR REQUIREMENT, PLEASE CONTACT WITH OUR ENGINEERS FOR FURTHER DISCUSSION.

ABOVE FIGURE ILLUSTRATES THE RECOMMENDED BEZEL AND CUSHION DESIGN. IN ORDER TO PREVENT

UNUSUAL PERFORMANCE DEGRADATION AND MALFUNCTION OF A TOUCH PANEL, PLEASE CARRY OUT THE SET

CASE DESIGNING AND A TOUCH PANEL ASSEMBLING METHOD AFTER SURELY CONSIDERING THE DEFINITION OF EACH AREA ILLUSTRATED IN ABOVE FIGURE.

### E M E R G I N G D I S P L A Y TECHNOLOGIES CORPORATION

MODEL NO. VERSION PAGE E T 0 3 5 0 0 9 D H 6 (RoHS) 1 16

AREA(a): ACTIVE AREA

THE ACTIVE AREA IS GUARANTEED THE POSITION DATA DETECTABLE PRECISION, OPERATION FORCE AND OTHER OPERATIONS. IT IS STRONGLY RECOMMENDED TO PLACE THE OPERATION BUTTON OR MENU KEYS WITHIN THE ACTIVE AREA. DUE TO STRUCTURE, THE ACTIVE AREA IS LESS DURABLE AT THE EDGE OR CLOSE TO THE EDGE.

AREA(b): OPERATION NON-GUARANTEED AREA

THIS AREA DOES NOT GUARANTEE A TOUCH PANEL OPERATION AND
ITS FUNCTION. WHEN THIS AREA IS PRESSED, TOUCH PANEL SHOWS
DEGRADATION OF ITS PERFORMANCE AND DURABILITY SUCH AS A PEN
SLIDING DURABILITY BECOMES ABOUT ONE-TENTH COMPARED WITH
THE ACTIVE AREA (AREA-(A) AS GUARANTEED AREA) AND ITS
OPERATION FORCE REQUIRES ABOUT DOUBLE. ABOUT 0.5 MM OUTSIDE
FROM A BOUNDARY OF THE ACTIVE AREA CORRESPONDS TO THIS AREA.

AREA(c): PRESSING PROHIBITION AREA

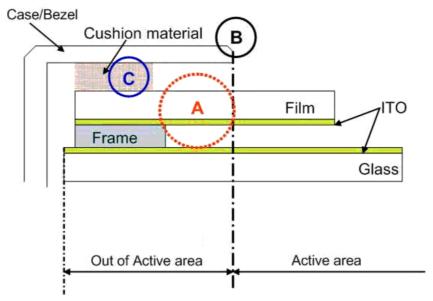
THE AREA WHICH FORBIDS PRESSING, BECAUSE AN EXCESSIVE LOAD IS
APPLIED TO A TRANSPARENT ELECTRODE (ITO) AND A SERIOUS DAMAGE
IS GIVEN TO A TOUCH PANEL FUNCTION BY PRESSING.

AREA(d): NON-ACTIVE AREA
THE AREA DOES NOT ACTIVATE EVEN IF PRESSED.

- (2) CAUTIONS FOR INSTALLING AND ASSEMBLING
  - (i) DO NOT GIVE EXCESSIVE STRAIN TO THE PRODUCT.
  - (ii) FLEXIBLE PATTERN CABLE IS CONNECTED TO THE BODY BY THERMAL PRESSURE METHOD. SO, DO NOT APPLY EXCESSIVE FORCES TO THE FLEXIBLE PATTERN. DO NOT ADD AN EXCESSIVE FORCE TO A FPC(FLEX TAIL) THAT MAKES PEELING OFF OF THE FPC FROM THE PRODUCT. DO NOT FIX, ADHERE OR MOUNT ANY ADDITIONAL GOODS ON THE FPC SUCH AS ADDITIONAL FILM/PLATE ON THE FPC, BECAUSE SUCH ADDITIONAL GOODS WILL APPLY A STRESS AT THE FPC BONDING AREA. IT MAY AFFECT THE CONDUCTIVITY OF FPC WITH TOUCH PANEL.
  - ( iii ) IN ORDER NOT TO APPLY LOAD ON THE DISPLAY, PROVIDE A CLEARANCE OF AT LEAST 0.3MM BETWEEN THE PRODUCT AND DISPLAY.
  - ( iv ) WE RECOMMEND THE DESIGN OF A CASE OR BEZEL SHOULD COVERS THE BOUNDARY OF THE ACTIVE AREA INSIDE IN ORDER TO PREVENT AN OPERATION AT OUTSIDE OF THE ACTIVE AREA WHICH CAN NOT GUARANTEE THE FUNCTION OR DURABILITY (REFER TO ITEM 5.1.2. STRUCTURE, AREA DEFINITION).

BEZEL'S EDGE PART MAY GUIDE THE PEN SLIDING ON THE SAME POSITION REPEATEDLY. IF THE BEZEL IS PLACED OUTSIDE OF THE ACTIVE AREA, IT MAY CAUSE THE DAMAGE OF THE ITO FILM.

( v ) PRESSING INSIDE OF BOUNDARY OF THE FRAME(PART (A) AS SHOWN IN BELOW) MAY CAUSES FAULT OPERATION, SO PLEASE DESIGN TO AVOID PRESSING OF TOUCH PANEL AT PART (A) SUCH AS HAVING GASKET/CUSHION AT PART (C). PARTICULARLY THE AREA (B) SHALL BE FREE FROM BURR. THE GASKET/CUSHION MATERIAL AT THE PART (C) SHOULD NOT BE EXCEEDED TO INSIDE OF THE BOUNDARY OF THE FRAME.



- ( vi ) TO PREVENT GIVING DISTORTION TO THE FILM OF THE PRODUCT AND PEELING OFF OF THE FILM FROM THE PRODUCT, DO NOT FIX THE FILM AND A SET CASE OR A SHOCK ABSORBING MATERIAL ADHERED TO A SET CASE BY ADHESION.
- (vii) WIPE OFF THE STAIN ON THE PRODUCT BY USING SOFT CLOTH MOISTENED WITH ETHANOL. TAKE CARE NOT TO ALLOW ETHANOL TO SOAK INTO THE JOINT OF UPPER FILM AND BOTTOM GLASS. IT MAY OTHERWISE CAUSE PEELING OR DEFECTIVE OPERATION. DO NOT USE ANY ORGANIC SOLVENT OR DETERGENT OTHER THAN ETHANOL.
- (viii) THE CORNERS OF THE PRODUCT ARE NOT CHAMFERED AND ARE SHARP. WHEN POSITIONING AND FIXING THE PRODUCT ON THE CASE, PROVIDE A ROUND PART ON THE CORNER OF THE CASE SO AS NOT TO APPLY LOAD ON THE CORNER OF THE TRANSPARENT TOUCH PANEL.
  - (ix) DO NOT PRESS THE FILM OF THE PRODUCT WHEN THIS PRODUCT IS BUILT INTO A SET.
- (3) CAUTIONS FOR OPERATION
  - (i) OPERATE IT WITH A POLYACETAL PEN (TIP R0.8 OR OVER) OR A BELLY OF A FINGER WITHOUT APPLYING EXCESSIVE LOAD. NEVER USE ANY MECHANICAL PENCILS, BALL POINT PENS AND HARD FINGERTIPS WHOSE TIP IS HARD FOR INPUT, OTHERWISE MALFUNCTIONS MAY RESULT.

MODEL NO.	VERSION	PAGE
ET035009DH6(RoHS)	1	18

- (ii) THE INPUT POSITION MAY BE FLUCTUATED A LITTLE THROUGH LONG-TIME USE. IT IS DESIRABLE TO PROVIDE A ZERO-ADJUSTMENT FUNCTION BY USING A CIRCUIT AND SOFTWARE.
- (iii) OPERATION AT THE OUT OF ACTIVE AREA IS OUT OF OUR GUARANTEE. IT CAUSES A SERIOUS DAMAGE OF A TRANSPARENT ELECTRODE. DO NOT OPERATE AT THE OUT OF ACTIVE AREA.
- (iv) IN CASE OF CLEANING THE PART OF THE CASE BOUNDARY OF ACCOMPLISHED SET, USE A SOFT CLOTH WITH A FINGER BERRY OR A COTTON BUD. DO NOT CLEAN WITH A THI NG OTHER THAN THE FINGER SUCH AS HARD OR SHARP EDGES LIKE A FINGER NAIL ETC. ON THE CLOTH, BECAUSE IT CAUSE TRANSPARENT CONDUCTIVE FILM CRACKS. PLEASE ADVISE THIS PROHIBITION TO YOUR LAST CUSTOMERS.

#### 12.4 DURABILITY

#### 12.4.1 STYLUS HITTING:

ONE MILLION TIMES OR OVER NO DAMAGE ON FILM SURFACE PEN: R8 mm SILICON RUBBER

LOAD: 250g

FREQUENCY: 240 times/min MEASUREMENT POSITION:

1 POINT OF TOUCH PANEL ACTIVE AREA

REPEATED: OVER 1,000,000 TIMES

#### 12.4.2 PEN TOUCH SLIDING DURABILITY:

100,000 TIMES OR OVER

WRITING WITH R0.8mm PLASTIC STYLUS PEN; WRITING FORCE 150g

IN ACTIVE AREA. SPEED IS 60mm/sec.

### EMERGING DISPLAY

TECHNOLOGIES CORPORATION

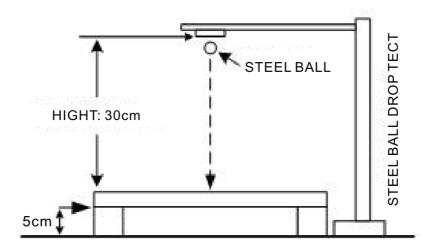
MODEL NO.	VERSION	PAGE
ET035009DH6(RoHS)	1	19

#### 12.5 STEEL BALL DROP TEST

BY USING F9mm STEEL BALL FROM THE HEIGHT OF 30cm AND FALLING ON TOUCH PANEL SURFACE, MUST PASS BELOW CONDITIONS:

APPEARANCE: THE APPEARANCE WITHOUT ANY CHANGE, INCLUDING

THE PANEL BROKEN.



#### 12.6 APPEARANCE INSPECTION

**PURPOSE**:

TO ESTABLISH APPEARANCE STANDARD AND MAINTAIN PRODUCT QUALITY  $\circ$ 

SCOPE:

TOUCH PANEL VIEW AREA WITHIN TOUCH PANEL •

#### 12.6.1 RULE:

INSPECTION CONDITION

- (A) ENVIRONMENTAL LUMINANCE: 500 LUX •
- (B) DISTANCE BETWEEN HUMAN EYES AND PANEL: 30 CM (PANEL MUST BE TESTED UNDER LIGHT TRANSPARENT) •
- (C) VISUAL ANGEL:  $> 60^{\circ}$
- (D) LIGHT SOURCE: FLUORESCENT LIGHT SOURCE •

#### 12.6.2 JUDGE CRITERION:

JUDGEMENT UNDER ABOVE MENTIONED CRITERION (PANEL MUST BE TESTED UNDER LIGHT TRANSPARENT),

TESTING GOODS DEFECT CAN BE VISIBLE WITHIN 10 SECONDS, WHICH WILL BE JUDGED AS MAJOR DEFECTS  $\circ$ 

#### SAMPLING STANDARD:

THE SAMPLING STANDARD WILL BE CONFIRMED BY BOTH OF EDT AND CUSTOMER.

 MODEL NO.
 VERSION
 PAGE

 ET035009DH6(RoHS)
 1
 20

INSPECTION ITEMS	SEPC.		JUDGE CRITERION	OPERATION GUIDELINE	
SCRATCH	W ≤ 0.1	mm & L≤10mm	ACCEPTABLE	REFL BACK GROUND	
SCRATCH	W > 0.1n	nm or L > 10mm	NOT ACCEPTABLE	TESTING GOODS FLUORESCENT LIGHT SOURCE	
LINEAR FOREIGN	W ≤ 0.1	mm & L ≤5mm	ACCEPTABLE	300mm	
OBJECT	W > 0.1	mm or L >5mm	NOT ACCEPTABLE	ENVIRONMENTAL 1UMINANCE : 500 Lu	
GRANULAR FOREIGN	D ≤ 0.3mm		ACCEPTABLE	FLUORESCENT LIGHT SOURCE  TESTING GOODS  300mm	
OBJECT	D	>0.3mm	NOT ACCEPTABLE	609 ENVIRONMENTAL 1UMINANCE : 500 Lu	
PET BUBBLES	D	≤0.6mm	ACCEPTABLE	D D	
PEI BUBBLES	D >0.6mm		NOT ACCEPTABLE		
CHIP ON GLASS	CORNER	$X \le 3$ mm $Y \le 3$ mm $Z < t$ $t = /t$ hickness	ACCEPTABLE	Chip of glass z	
	EDGE	$W \le 3mm \cdot Y \le 3mm \cdot Z < t$			

### EMERGING DISPLAY

TECHNOLOGIES CORPORATION

MODEL NO.	VERSION	PAGE
ET035009DH6(RoHS)	1	21

#### 13. SPECIFICATION OF AUDACITY ASSURANCE

#### 13.1 APPLICATION

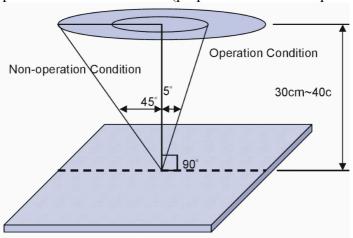
This inspection standard is to be applied to the LCD module delivered from EMERGING DISPLAY TECHNOLOGIES CORP.( E.D.T ) to customers

#### 13.2 INSPECTION CONDITIONS

13.2.1 (1)Observation Distance: 35cm±5cm

(2)View Angle:

Non-operation Condition :  $\pm 5^{\circ}$  (perpendicular to LCD panel surface) Operation Condition :  $\pm 45^{\circ}$  (perpendicular to LCD panel surface)



#### 13.2.2 Environment Conditions:

Amb	ient Temperature	20°C~25°C
Ambient Humidity		65±20%RH
Ambient Cosmetic Inspection		More than 600Lux
Illumination Functional Inspection		300~500 Lux

#### 13.2.3 Inspection lot

Quantity per delivery lot for each model

#### 13.2.4 Inspection method

A sampling inspection shall be made according to the following provisions to judge The acceptability

(a) Applicable standard: MIL-STD-105E

Normal inspection, single sampling

Level II

(b)AQL : Major defect : AQL 0.65% Minor defect : AQL 1.0%

MODEL NO.	VERSION	PAGE
ET035009DH6(RoHS)	1	22

#### 13.3 INSPECTION STANDARDS

#### 13.3.1 VISUAL DEFECTS CLASSIFICATION

TYPE OF DEFECT	INSPECTION ITEM	DEFECT FEATURE	AQL
MAJOR DEFECT	1.DISPLAY ON	DEFECT TO MISS SPECIFIED     DISPLAY FUNCTION, FOR ALL     AND SPECIFIED DOTS     EX: DISCONNECTION, SHORT     CIRCUIT ETC	0.65
	2.BACKLIGHT	NO LIGHT     FLICKERING AND OTHER     ABNORMAL ILLUMINATION	0.65
	3.DIMENSIONS	• SUBJECT TO INDIVIDUAL ACCEPTANCE SPECIFICATIONS	
	1.DISPLAY ZONE	<ul> <li>BLACK/WHITE SPOT</li> <li>BUBBLES ON POLARIZER</li> <li>NEWTON RING</li> <li>BLACK/WHITE LINE</li> <li>SCRATCH</li> <li>CONTAMINATION</li> <li>LEVER COLOR SPREED</li> </ul>	
MINOR DEFECT	2.BEZEL ZONE	<ul><li>STAINS</li><li>SCRATCHES</li><li>FOREIGN MATTER</li></ul>	1.0
	3.SOLDERING	<ul> <li>INSUFFICIENT SOLDER</li> <li>SOLDERED IN INCORRECT         POSITION</li> <li>CONVEX SOLDERING SPOT</li> <li>SOLDER BALLS</li> <li>SOLDER SCRAPS</li> </ul>	
	4.DISPLAY ON (ALL ON)	• LIGHT LINE	

### EMERGING DISPLAY

TECHNOLOGIES CORPORATION

 MODEL NO.
 VERSION
 PAGE

 E T 0 3 5 0 0 9 D H 6 (RoHS)
 1
 23

#### 13.3.2 MODULE DEFECTS CALSSIFICATION

NO.	ITEM	E DEFECTS CALSSIFICATION  CRITERIA		
1.	DISPLAY ON INSPECTION	(1)INCORRECT PATTERN (2)MISSING SEGMENT (3)DIM SEGMENT (4)OPERATING VOLTAGE BEYOND SPEC		
2.	OVERALL DIMENSIONS	(1)OVERALL DIMENSION BEYOND SPEC		
3.	BLACK SPOTS, FOREIGN MATTER, AND WHITE SPOTS (INCLUDING LIGHT LEAKAGE DUE TO POLARIZING PLATES PINHOLES, ETC.)	AVERAGE DIAMETER   NUMBER OF PIECES   MINIMUM   SPACE    D≤0.2   IGNORE   —    0.2 <d≤0.4 (2)="" (when="" 0="" 0.3<d≤0.75="" 0.4<d="" 0.75<d="" 10="" 2="" 5="" :="" are="" as="" average="" be="" blurry="" concentrated.="" considered="" d="(a+b)/2" diameter="" d≤0.3="" fully="" ignore="" is="" mm="" more,="" not="" note="" note:="" number="" of="" or="" pieces="" pieces.="" powered-on)="" set="" spots="" td="" that="" there="" they="" they<="" to="" total="" when="" within=""  =""></d≤0.4>		
4.	BLACK LINE WHITE LINE NON-DISPLAY	ARE NOT TO BE CONSIDERED AS CONCENTRATED.  (1)THE BLACK LINE, WHITE LINE ARE WITHIN THE VIEWING AREA. IT IS NOT ALLOW.		
5	BLACK LINE WHITE LINE ON-DISPLAY	(1) THE FOLLOWING BLACK LINE , WHITE LINE ARE WITHIN THE VIEWING AREA. WIDTH :Wmm , LENGH :Lmm		
6.	SCRATCHES AND DENT ON GLASS POLARIZER	(1) PLS REFER TO THE ABOVE NO.3 AND 4 TO DETERMINE SCRATCHES AND DENT ON POLARIZER OR GLASS		
7.	DOT DEFECT ON DISPLAY	Judgment Criteria  Area Bright Dot Dark Dot Total  A 3 3 4  B 5 5 5  (1) It is defined as Point Defect if defect area>0.5dot (2) It is ignored if defect area≤0.5dot (3) Weak point defect will be defined as Bright Dot if it can be observed through ND filter 6% (4) The distance between 2 dot defect≥5mm (5) Not Allowed Joint point defect		

 MODEL NO .
 VERSION
 PAGE

 E T 0 3 5 0 0 9 D H 6 (RoHS)
 1
 24

NO.	ITEM	CRITERIA		
8	LINE DEFECT ON	OBVIOUS VERTICAL OR HORIZONTAL LINE DEFECT IS		
0	DISPLAY	NOT ALLOW		
9	MURA ON DISPLAY	IT'S OK IF MURA IS SLIGHT VISIBLE THROUNG 6% NI FILTER		
		(1)THE FOLLOWING CF FAIL , SPOT ARE WITHIN THE VIEWING AREA		
	CF FAIL/SPOT ON	SIZE D PERMISSIBLE NO. Note: Diameter D=(a+b)/2		
10	DISPLAY	$D \le 0.15$ mm IGNORED		
	DISFLAT	$0.15$ mm $<$ D $\leq$ 0.2mm $N \leq 2$		
		D > 0.2mm NOT ALLOWED		
11	UNEVEN COLOR SPREAD , COLORATION	(1)TO BE DETERMINED BASED UPON THE STANDARD SAMPLE.		
12	BEZEL APPEARANCE	(1)BEZEL MAY NOT HAVE RUST, E DEFORMED OR HAVE FINGER PRINTS STAINS OF OTHER CONTAMINATION. (2)BEZEL MUST COMPLY WITH JOB SPECIFICATIONS.		
13	SOLDERING	(a)LSI, IC A POOR WETTING OF SOLDER IS BETWEEN LOWER BEND OR "HEEL" OF LEAD AND PAD  SOLDER FILLET  (b)CHIP COMPONENT · SOLDER IS LESS THAN 50% OF SIDES AND FRONT FACE WETTING  SOLDER FILLET		

MODEL NO. VERSION E T 0 3 5 0 0 9 D H 6 (RoHS) 1

PAGE

25

NO.	ITEM	CRITERIA
		SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS     THAN 25% OF SIDES AND FRONT SURFACE AREA ARE     COVERED      SOLDER
13. S	OLDERING	(3)PARTS ALIGMENT  (a)LSI, IC LEAD WIDTH IS MORE THAN 50% BEYOND PAD OUTLINE
		(b)CHIP COMPONENT COMPONENT IS OFF CENTER, AND MORE THAN 50% OF THE LEADS IS OFF THE PAD OUTLINE

 MODEL NO.
 VERSION
 PAGE

 E T 0 3 5 0 0 9 D H 6 (RoHS)
 1
 26

NO.	ITEM	CRITERIA
		(4)NO UNMELTED SOLDER PASTE MAY BE PRESENT
		ON THE PCB.
12	SOLDERING	(5)NO COLD SOLDER JOINTS, MISSING SOLDER
13.	SOLDERING	CONNECTIONS, OXIDATION OR ICICLE.
		(6)NO RESIDUE OR SOLDER BALLS ON PCB.
		(7)NO SHORT CIRCUITS IN COMPONENTS ON PCB.
		(1)NO LIGHT
		(2)FLICKERING AND OTHER ABNORMAL ILLUMINATION
1.4	BACKLIGHT	(3)SPOTS OR SCRATCHES THAT APPEAR WHEN LIT
14.	DACKLIGITI	MUST BE JUDGED USING LCD SPOT, LINES AND
		CONTAMINATION STANDARDS.
		(4)BACKLIGHT DOESN'T LIGHT OR COLOR IS WRONG.
		(1)NO OXIDATION, CONTAMINATION, URVES OR, BENDS
		ON INTERFACE PIN (OLB) OF TCP.
		(2)NO CRACKS ON INTERFACE PIN (OLB) OF TCP.
		(3)NO CONTAMINATION, SOLDER RESIDUE OR SOLDER
		BALLS ON PRODUCT.
		(4) THE IC ON THE TCP MAY NOT BE DAMAGED, CIRCUITS.
		(5)THE UPPERMOST EDGE OF THE PROTECTIVE STRIP ON
		THE INTERFACE PIN MUST BE PRESENT OR LOOK AS
		IF IT CAUSE THE INTERFACE PIN TO SEVER.
		(6)THE RESIDUAL ROSIN OR TIN OIL OF SOLDERING
	GENERAL	(COMPONENT OR CHIP COMPONENT) IS NOT BURNED
15.	APPEARANCE	INTO BROWN OR BLACK COLOR.
		(7)SEALANT ON TOP OF THE ITO CIRCUIT HAS NOT
		HARDENED.
		(8)PIN TYPE MUST MATCH TYPE IN SPECIFICATION
		SHEET.
		(9)LCD PIN LOOSE OR MISSING PINS.
		(10)PRODUCT PACKAGING MUST THE SAME AS
		SPECIFIED ON PACKAGING SPECIFICATION SHEET.
		(11)PRODUCT DIMENSION AND STRUCTURE MUST
		CONFORM TO PRODUCT SPECIFICATION SHEET.
		(12)THE APPEARANCE OF HEAT SEAL SHOULD NOT
		ADMIT ANY DIRT AND BREAK.

 MODEL NO.
 VERSION
 PAGE

 E T 0 3 5 0 0 9 D H 6 (RoHS)
 1
 27

NO.	ITEM		CRITERIA		
		THE LCD WITH EXTEN	SIVE CRAC	K IS NOT ACCEI	PTABLE
		General glass chip:	a	b	c
		b	≤ t/2	< VIEWING AREA	≤ 1/8X
		L CHALL	$t/2 > , \le 2t$	≤ W/2	≤ 1/8X
				NCE BETWEEN	
				NT AREA AND I	LCD
			PANEL		
		C		SIDE LENGTH	
				S THICKNESS	
		a			
		To T			
		L'Crand			
		30			
		Take Take			
		Companyant	a	b	c
		Corner part:	≤ t/2	< VIEWING AREA	$\leq 1/8X$
			$> t/2$ , $\leq 2t$	$\leq$ W/2	$\leq 1/8X$
		° C	*W=DISTA	NCE BETWEEN	
16.	CRACKED GLASS	a -	SEALA	NT AREA AND I	LCD
			PANEL		
				DE LENGTH	
			t=GLASS	THICKNESS	Т
		CHIP ON ELECTRODE PAD	a	b	c
		3	≤ t	≤ 0.5mm	$\leq 1/8X$
		Co. Co.		DE WIDTH	
		To the state of th	t =GLASS	THICKNESS	
			a	b	c
		***************************************	≤ t	≤ 1/8X	≤L
		° a	*X=LCD SII	DE WIDTH	
		, , , b	t = GLASS	THICKNESS	
			L=ELECTF	RODE PAD LENC	STH
				CHIPPING THE IT	
				L, OVER 2/3 OF T	HE ITO
				MAIN AND BE,	
				DE TERMINAL	U
			SPECIFICA	DE TERMINAL	
				ATIONS ODUCT WILL BE I	HEAT
				BY THE CUSTOME	
				NT MARK MUST	
		1	DEMAGEI		

 MODEL NO.
 VERSION
 PAGE

 E T 0 3 5 0 0 9 D H 6 (RoHS)
 1
 28

#### 13.4 RELIABILITY TEST

#### 13.4.1 STANDARD SPECIFICATIONS FOR RELIABILITY OF LCD MODULE

NO	ITEM	DESCRIPTION
1	High temperature operation	The sample should be allowed to stand at +60°C for 240 hrs
2	Low temperature operation	The sample should be allowed to stand at -10°C for 240 hrs
3	High temperature storage	The sample should be allowed to stand at +70°c for 240 hrs
4	Low temperature storage	The sample should be allowed to stand at -20°C for 240 hrs
5	High temp / humidity test	The sample should be allowed to stand at 60°C, 90% RH 240 hrs
6	Thermal shock (not operated )	The sample should be allowed to stand the following 200 cycles of operation:  -25°c for 30 minutes ~ +70°c for 30 minutes
7	ESD (Electrostatic Discharge)	AIR DISCHARGE ± 4KV CONTACT DISCHARGE ± 2KV

NOTE (1): THE TEST SAMPLES HAVE RECOVERY TIME FOR 2 HOURS AT ROOM TEMPERATURE BEFORE THE FUNCTION CHECK. IN THE STANDARD CONDITIONS, THERE IS NO DISPLAY FUNCTION NG ISSUE OCCURRED.

### E M E R G I N G D I S P L A Y TECHNOLOGIES CORPORATION

MODEL NO.	VERSION	PAGE
ET035009DH6(RoHS)	1	29

#### 13.5 TESTING CONDITIONS AND INSPECTION CRITERIA

For the final test the testing sample must be stored at room temperature for 24 hours, after the tests listed in table 12.5, standard specifications for reliability have been executed in order to ensure stability.

NO	ITEM	TEST MODEL	INSPECTION CRITERIA
1	Current	Refer To Specification	The current consumption should
1	consumption	Kelei 10 Specification	conform to the product specification.
			After the tests have been executed,
2	Contrast	Refer TO Specification	the contrast must be larger than half
			of its initial value prior to the tests.
3	Appearance	Visual inspection	Defect free

### EMERGING DISPLAY

TECHNOLOGIES CORPORATION ET035009DH6(F

MODEL NO. VERSION PAGE E T 0 3 5 0 0 9 D H 6 (RoHS) 1 30

#### 13.6 OPERATION

- 13.6.1 Do not connect or disconnect modules to or from the main system while power is being supplied .
- 13.6.2 Use the module within specified temperature; lower temperature causes the retardation of blinking speed of the display; higher temperature makes overall display discolor. When the temperature returns to normality, the display will operate normally.
- 13.6.3 Adjust the LC driving voltage to obtain the optimum contrast.
- 13.6.4 Power On Sequence input signals should not be supplied to LCD module before power supply voltage is applied and reaches the specified value . If above sequence is not followed, CMOS LSIs of LCD modules may be damaged due to latch up problem.

#### 13.7 NOTICE

- 13.7.1 Use a grounded soldering iron when soldering connector I/O terminals . For soldering or repairing , take precaution against the temperature of the soldering iron and the soldering time to prevent peeling off the through-hole-pad .
- 13.7.2 Do not disassemble . EDT shall not be held responsible if the module is disassembled and upon the reassembly the module failed .
- 13.7.3 Do not charge static electricity, as the circuit of this module contains CMOS LSIs. A workman's body should always be static-protected by use of an ESD STRAP. Working clothes for such personnel should be of static-protected material.
- 13.7.4 Always ground the electrically-powered driver before using it to install the LCD module. While cleaning the work station by vacuum cleaner, do not bring the sucking mouth near the module; static electricity of the electrically-powered driver or the vacuum cleaner may destroy the module.
- 13.7.5 Don't give external shock.
- 13.7.6 Don't apply excessive force on the surface.
- 13.7.7 Liquid in LCD is hazardous substance. Must not lick and swallow. When the liquid is attach to your, skin, cloth etc. Wash it out thoroughly and immediately.
- 13.7.8 Don't operate it above the absolute maximum rating.
- 13.7.9 Storage in a clean environment, free from dust, active gas, and solvent.
- 13.7.10 Store without any physical load.
- 13.7.11 Rewiring: no more than 3 times.